

FHR Line2500^{TCO}

Magnetron sputter system for the deposition of transparent conductive oxides (TCO)

Description of system

The magnetron sputter system FHR.Line.2500-TCO is based on the inline platform FHR.Line.2500-PVD and has been specially designed for the deposition of transparent conductive oxides (TCO) onto large-area flat glass plates. The sputter system is laid out as an inline system with process stations positioned one after the other. Coating is performed continuously in a single passage with cyclic loading of the substrates. The FHR.Line.2500-TCO is optimized for the highest substrate throughput rates and guarantees maximum productivity.

Process

- ▲ Sputter deposition of ZnO:Al (aluminum-doped zinc oxide),
- ▲ Sputter deposition of ITO (tin-doped indium oxide)

Advantages for customers

- ▲ Low investment costs and operating costs
- ▲ Overall length of the plant kept very short thanks to the use of proprietary FHR sputter technology (minimized footprint)
- ▲ Excellent layer uniformity with minimized protrusion of the target thanks to the unique FHR cathode design
- ▲ Extended production interval (2 to 3 weeks) thanks to the use of tubular targets with specially adapted magnetron environment
- ▲ Excellent target yield (tubular targets up to 80 %)
- ▲ No restrictions in terms of the integration of third-party sputter sources
- ▲ Simplified maintenance of the chamber sealing faces through innovative supporting of the vacuum chambers
- ▲ Reduced time outlay for modification or upgrades thanks to the modular design of the sputter system

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Key data

Dimensions

length	width	height
24,260 mm	9000 mm	2200 mm

Weight

approx. 100,000 kg

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Substrate size	flat glass up to GEN 8 (target length: 2500 mm)
Throughput (typical cycle time)	< 60 s per substrate
Substrate temperature	RT to 300 °C (max.)
Uniformity of the layer thickness	+/- 3 %
Effective production time (up-time)	> 85 %

Special features

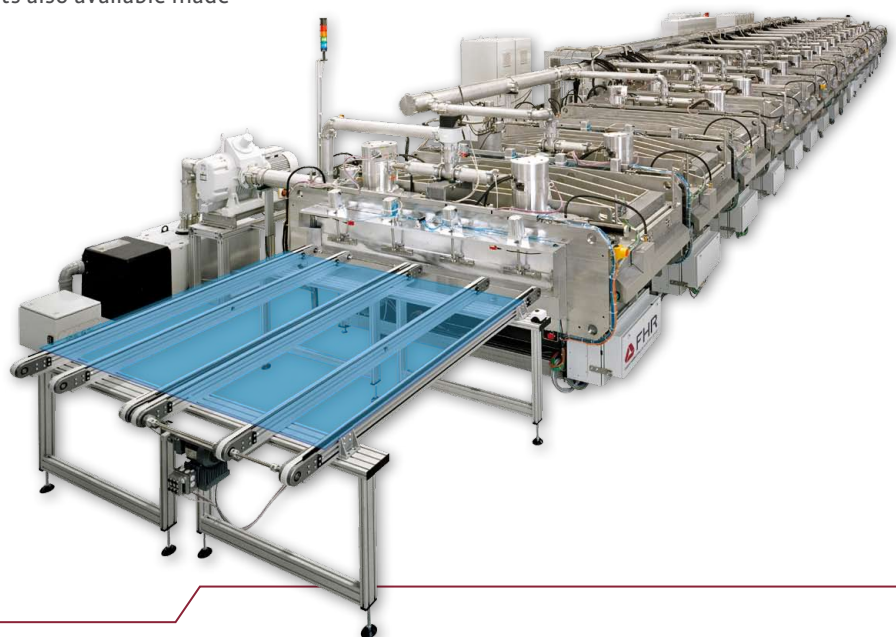
- ▲ Linear substrate transport with horizontal substrate positioning
- ▲ Integrated substrate heating
- ▲ Various different source types can be used (tubular targets, planar targets)
- ▲ Vacuum chambers and built-in components made of stainless steel

Options

- ▲ Customer-specific adaptation to suit the individual productivity requirements and layer system
- ▲ Individual combination of pre/post-treatment steps
- ▲ Optional conditioning for downtime shortening
- ▲ Vacuum chambers and built-in components also available made of construction steel

Typical applications

- ▲ Deposition of contact layers for thin-film solar cells
- ▲ Coating of architectural glass („heat reflectors“)
- ▲ Deposition of functional layers for display technology and OLEDs



Thin-film equipment. Customized.